



Nanocomposites: New Building Blocks for MEMS

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Abstract

Microelectromechanical systems (MEMS) are currently built from silicon, some metals, and a few other materials. Few ceramic materials are available for microfabrication. Contrast this situation with the fact that many revolutionary devices and processes in the macroscopic world involve ceramics and composites. The incorporation of ceramics into microscopic devices would allow the exploitation of novel properties such as increased toughness, high temperature inertness, chemical and biological compatibility, magnetism, piezoelectricity, and photochromism.

In this talk, we will present recent results on the fabrication of functional MEMS microcomponents from ceramic nanocomposites. Our fabrication techniques consist of: 1) micromold fabrication; 2) formulation of a nanocomposite mixture; 3) micromolding. Micromolded components can be produced free standing or assembled on substrates. By using particles a few nanometer in diameters, we are able to mold components with lateral dimensions in the order of a few microns. Microscopy studies indicate that molding of submicron size features should be possible with nanocomposites. This process is compatible with existing integrated circuit manufacturing processes.



Motivation

Limited number of materials and materials properties currently available for microfabrication

- Silicon and some of its compounds
- Thin (few microns) metal films
- Some polymers
- Thin ceramic films

Research Challenge: To develop microfabrication techniques that introduce materials with novel properties

Answer: Micromolding of ceramic nanocomposites

- Ceramic nanoparticles less than 100 nm in diameter
- Nanoparticles are now readily available
- Variety of materials properties
- Novel properties induced by nanometer dimensions

Ceramic Nanoparticles

Function	Class	Material
Magnetic	Soft	MnFe₂O₄
	Hard	SmCo₅, NdFeB
Electrical	Insulator	Al₂O₃
	Piezoelectric	PbZr_{0.5}Ti_{0.5}O₃
	Ferroelectric	BaTiO₃
Optical	Transparent	Al₂O₃
	Photochromic	MoO₃, WO₃
Mechanical	Refractory	Al₂O₃, SiC
	Wear resistant	Al₂O₃, ZrO₂

Ceramic Nanoparticles

Function	Class	Material
Mechanical	Cutting	Al₂O₃, ZrO₂
	Lubrication	MoS₂
Thermal	Insulation	Al₂O₃, SiO₂
	Radiator	ZrO₂, TiO₂
Chemical	Gas sensor	ZnO, ZrO₂
	Filter	SiO₂, Al₂O₃
Biological	Biocompatible	Ca₅(PO₄)₃OH

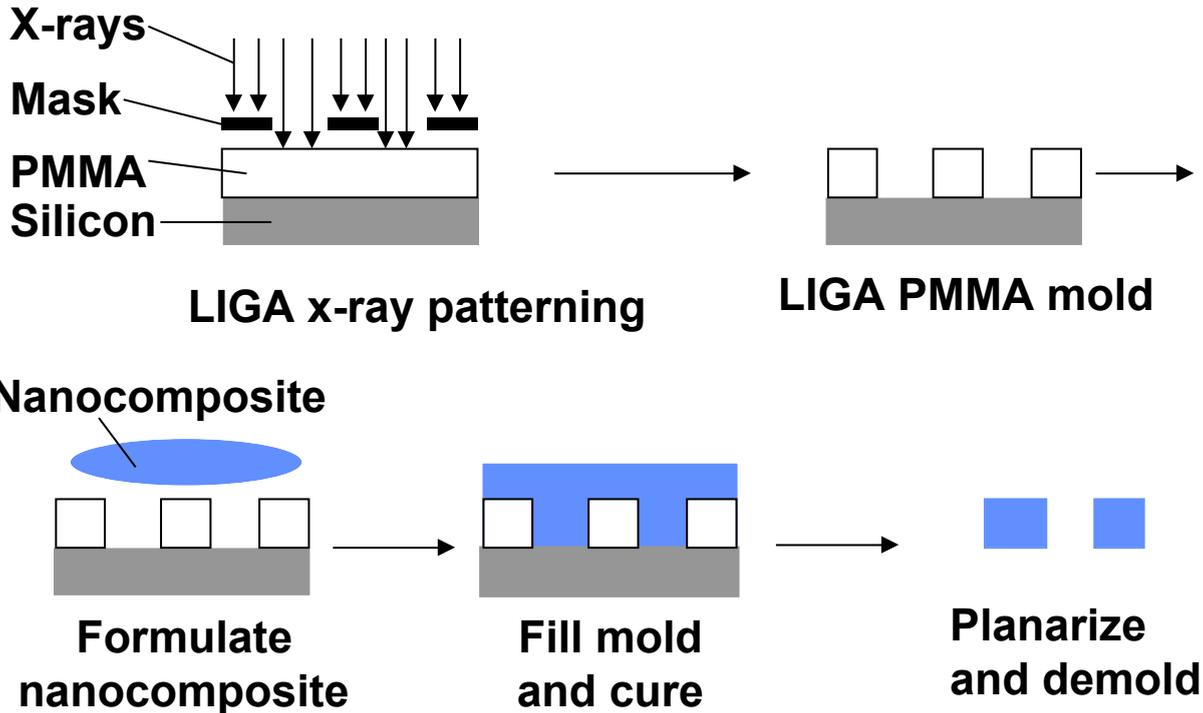


Experimental Approach

Micromolding of nanocomposites:

- Fabricate high aspect ratio micromolds with LIGA.**
- Develop nanocomposite formulation amenable to micromolding.**
- Fabricate micromolds on functional substrates such as silicon and alumina.**

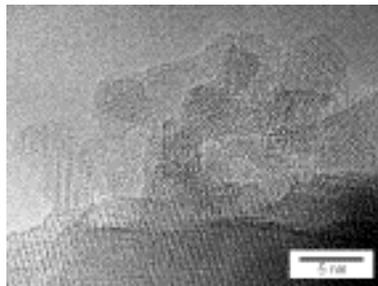
Results: High Aspect Ratio Microparts



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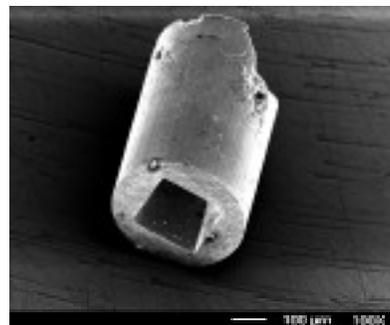


+



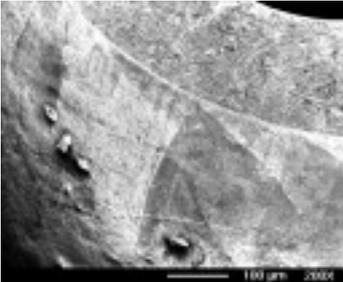
+ 30% w/w Epoxy

LIGA PMMA mold MnFe₂O₄ nanoparticles

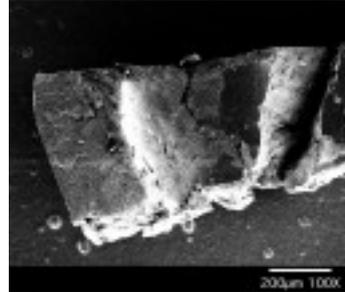


High aspect ratio MnFe₂O₄ nanocomposite microparts

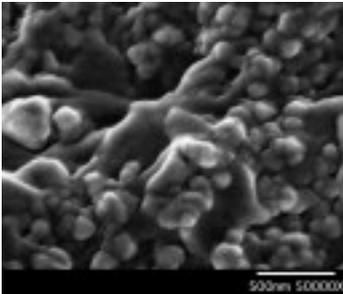
Results: High Aspect Ratio Microparts



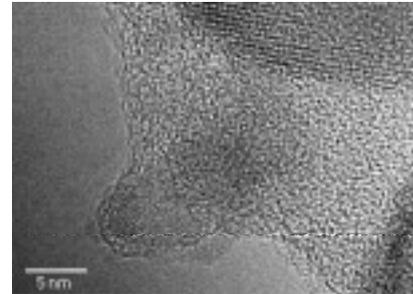
**SEM of MnFe₂O₄
nanocomposite micropart**



**MnFe₂O₄ nanocomposite micropart
used for high resolution studies**



**High resolution SEM: nanocomposite
aggregates into particles less
than 100 nm in diameter**

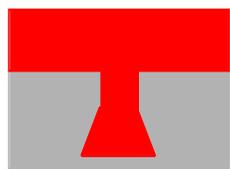
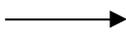


**High resolution TEM:
MnFe₂O₄ nanoparticles embedded
in polymer**

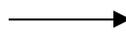
Results: Microparts on Functional Substrates



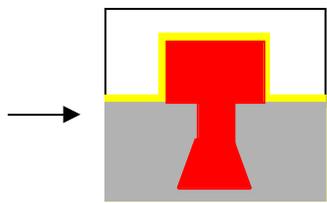
**Etch dovetail
into silicon**



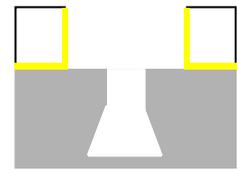
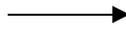
**Cover with
photoresist**



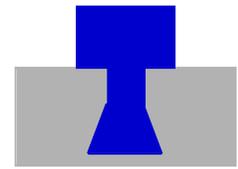
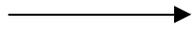
**Pattern micropart
in photoresist and seal**



**Encase micropart
in PMMA**

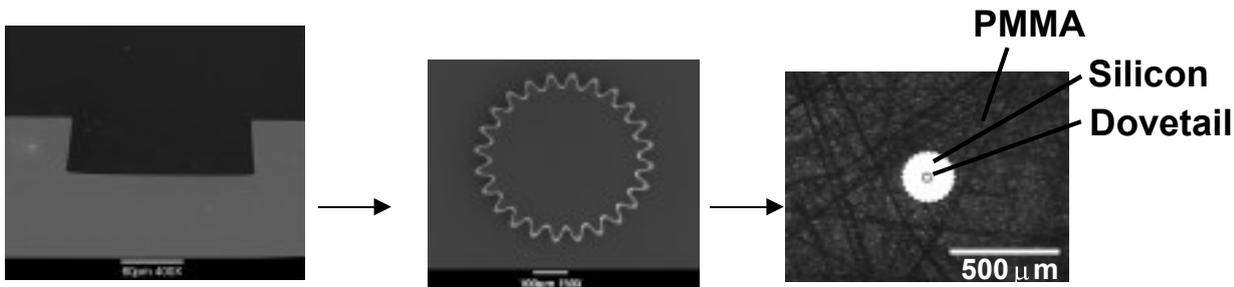


**Polish back to reach
the top of the photoresist
and dissolve photoresist.**

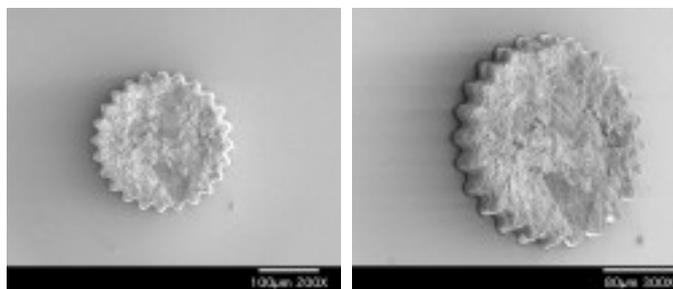


**Micromold
nanocomposite**

Results: Microparts on Functional Substrates

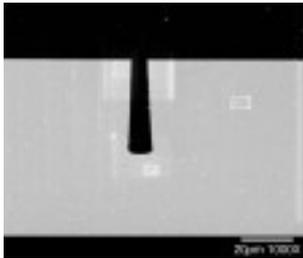


Dovetail in silicon Sealed Photoresist on silicon Micromold

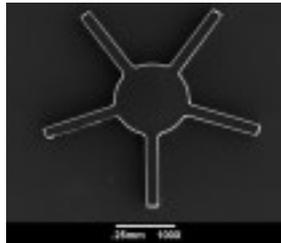


MnFe_2O_4 nanocomposite micropart on silicon

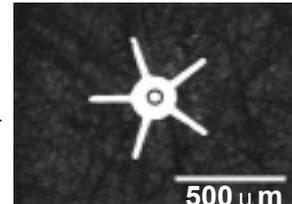
Results: Microparts on Functional Substrates



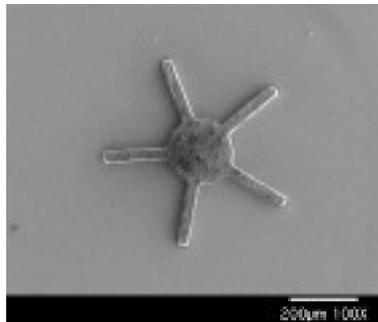
Dovetail in silicon



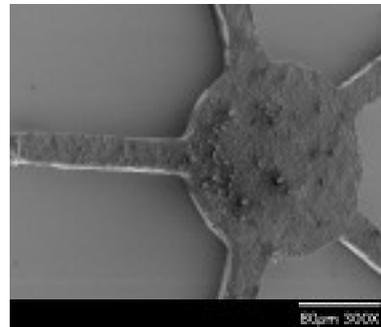
Sealed photoresist
on silicon



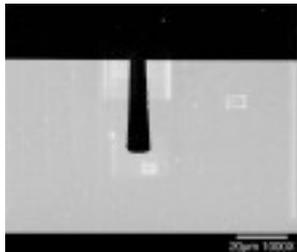
Micromold



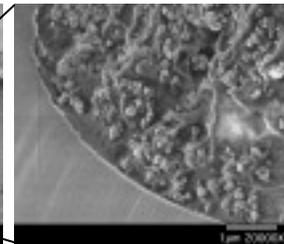
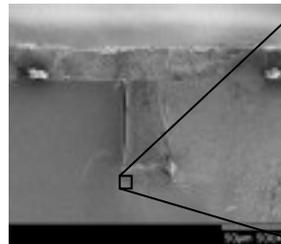
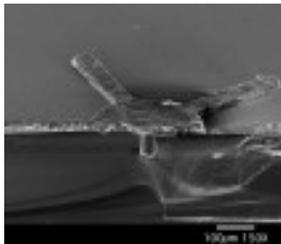
MnFe₂O₄ nanocomposite micropart
on silicon



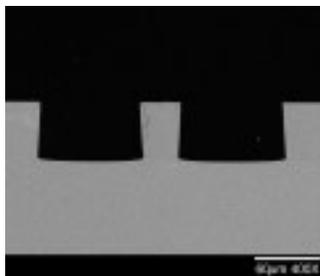
Results: Microparts on Functional Substrates



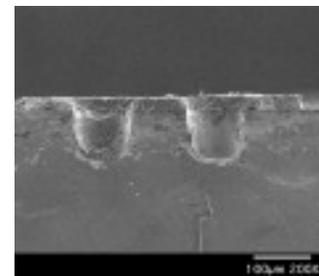
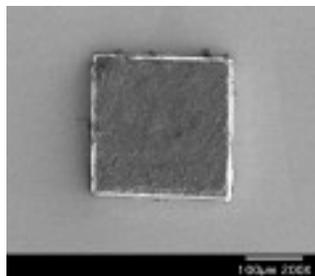
Dovetail in silicon



MnFe₂O₄ nanocomposite micropart anchored with dovetail into silicon



Dovetails in silicon



MnFe₂O₄ nanocomposite micropart anchored with four dovetails into silicon

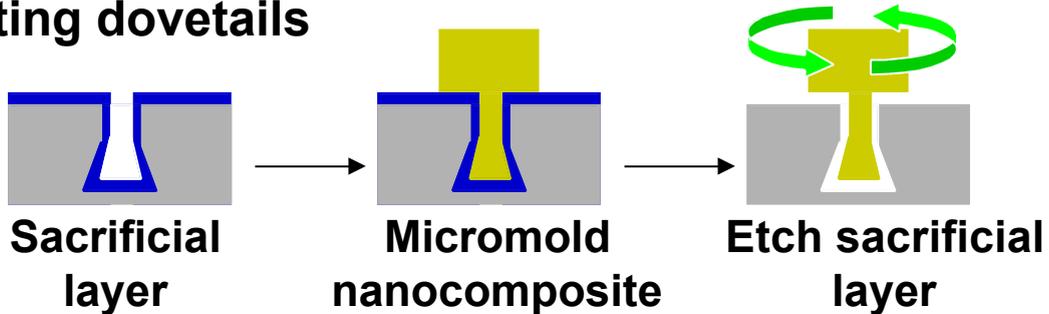


Conclusions

- **Combined LIGA and micromolding to produce free standing high aspect ratio ceramic nanocomposite microparts**
- **Combined silicon etching, lithography, and micromolding to produce ceramic nanocomposite microparts on silicon**
- **Microscopy studies indicate molding of submicron features should be possible with ceramic nanocomposites.**

Work in Progress

- Rotating dovetails



- Micromolding other nanocomposites
- Sintered ceramic parts (no binder)
- Characterization
- Looking for collaborators interested in making devices



Thanks to

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Nancy Yang

Jeff Chames

Andy Gardea

Doug Medlin

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Prof. Z. John Zhang and his group

Silicon etching carried out at the

UC Berkeley Microlab